

### LASER DIODE

# **NDL7605P Series**

# 1 310 nm OPTICAL CATV RETURN PATH APPLICATIONS IngaAsp MQW DFB LASER DIODE MODULE WITH ISOLATOR

#### **DESCRIPTION**

The NDL7605P Series is a 1 310 nm uncooled isolated coaxial DFB laser diode. It is especially designed for optical CATV return path applications.

#### **FEATURES**

• Low distortion IMD2 =  $-50 \text{ dBc MAX.}^{*1}$ @ Tc =  $25 ^{\circ}$ C

IMD2 = -45 dBc MAX.  $^{\text{1}}$ @ Tc = -40 to +85  $^{\circ}$ C IMD3 = -60 dBc MAX.  $^{\text{1}}$ @ Tc = -40 to +85  $^{\circ}$ C

• Output power  $P_f = 2.0 \text{ mW}$ • Long wavelength  $\lambda_P = 1.310 \text{ nm}$ 

· Internal InGaAs monitor PD and isolator

• Single mode fiber pigtail with FC-UPC, SC-UPC or SC-APC connector

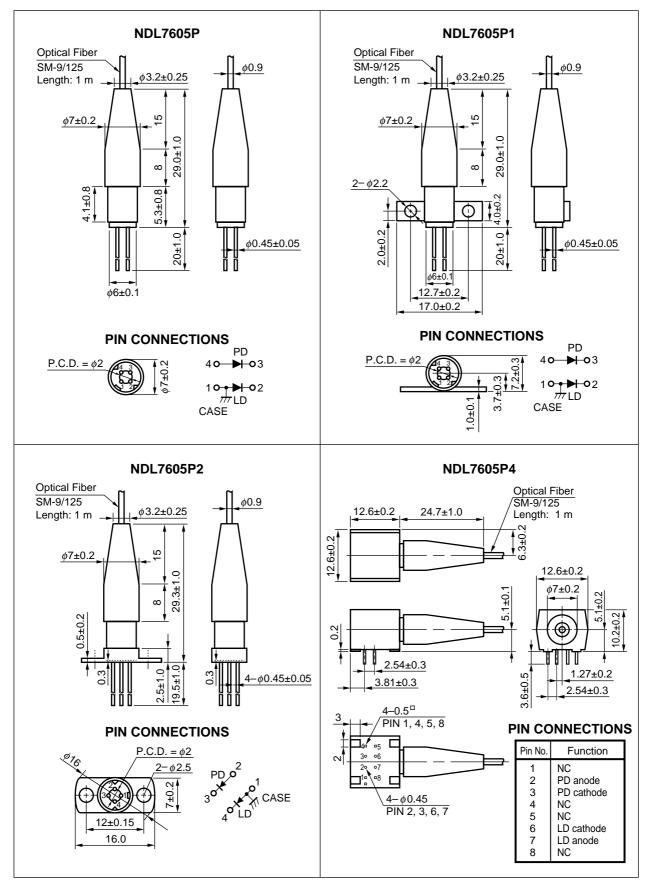
Wide operating temperature range Tc = −40 to +85 °C

\*1 2-ch, Optical loss = 7 dB, OMI = 10 %/ch

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

#### **PACKAGE DIMENSIONS (in millimeters)**





#### ORDERING INFORMATION

Part Number	Available Connector	Flange Type	
NDL7605PC	With FC-UPC Connector	No Flange	
NDL7605PD	With SC-UPC Connector		
NDL7605PX	With SC-APC Connector		
NDL7605P1C	With FC-UPC Connector	Flat Mount Flange	
NDL7605P1D	Vith SC-UPC Connector		
NDL7605P1X	With SC-APC Connector		
NDL7605P2C	With FC-UPC Connector	Vertical Flange	
NDL7605P2D	With SC-UPC Connector		
NDL7605P2X	With SC-APC Connector		
NDL7605P4C	With FC-UPC Connector	Lead Bend	
NDL7605P4D	With SC-UPC Connector		
NDL7605P4X	With SC-APC Connector		

### ABSOLUTE MAXIMUM RATINGS (Tc = 25 °C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Optical Output Power from Fiber	Pf	5	mW
Forward Current of LD	lF	Ith + 50	mA
Reverse Voltage of LD	VR	2.0	V
Forward Current of PD	lF	10	mA
Reverse Voltage of PD	VR	15	٧
Operating Case Temperature	Tc	-40 to +85	°C
Storage Temperature	Tstg	-40 to +85	°C
Lead Soldering Temperature (10 s)	Tsld	260	°C

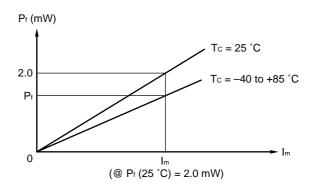
#### **ELECTRO-OPTICAL CHARACTERISTICS**

(Tc = 25 °C, Optical Reflection ≤ -50 dB, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward Voltage	VF	IF = 30 mA	0.9	1.1	1.3	V
Optical Output Power from Fiber	Pf	CW		2.0		mW
Threshold Current	Ith	CW		15	30	mA
		CW, Tc = 85 °C		40	60	
Differential Efficiency from Fiber	$\eta_{ extsf{d}}$	P <sub>f</sub> = 2.0 mW	0.080	0.200		W/A
Temperature Dependence of Differential Efficiency from Fiber	$\Delta\eta$ d	$P_f = 2.0 \text{ mW}, \ \eta \ (85 ^{\circ}\text{C}) \ / \ \eta \ (25 ^{\circ}\text{C})$	-3.0			dB
Peak Emission Wavelength	λρ	P <sub>f</sub> = 2.0 mW, RMS (–20 dB)	1 290	1 310	1 330	nm
Side Mode Suppression Ratio	SMSR	P <sub>f</sub> = 2.0 mW	30			dB
2nd Order Inter-modulation Distortion	IMD2	*1			-50	dBc
		*1, Tc = -40 to +85 °C			-45	
3rd Order Inter-modulation Distortion	IMD3	*1, Tc = -40 to +85 °C			-60	dBc
Carrier to Noise Ratio	CNR	*1, Tc = -40 to +85 °C	52			dB
Monitor Current	lm	VR = 5 V, Pf = 2.0 mW	100	500	1 000	μΑ
Dark Current	lο	VR = 5 V		0.1	10	nA
Tracking Error	γ*2	I <sub>m</sub> = const., P <sub>f</sub> = 2.0 mW, T <sub>C</sub> = -40 to +85 °C			1.5	dB
Optical Isolation	ISO		30			dB

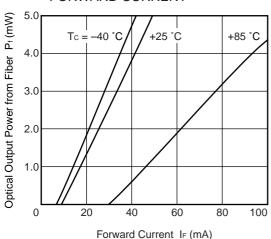
\*1 Conditions:  $P_f$  = 2.0 mW,  $T_C$  = 25 °C, 2 channel unmodulated carriers 13 MHz and 19 MHz, Optical Reflection = -50 dB, Optical Loss = 7 dB, OMI = 10 %/ch

\*2 
$$\gamma = 10 \log \frac{P_f}{2.0 \text{ mW}}$$

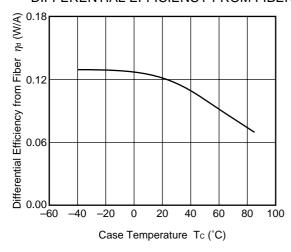


#### **★** TYPICAL CHARACTERISTICS (Tc = 25 °C, unless otherwise specified)

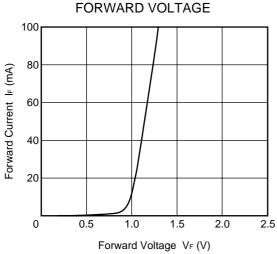




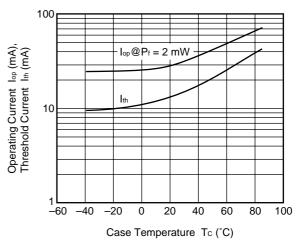
## TEMPERATURE DEPENDENCE OF DIFFERENTIAL EFFICIENCY FROM FIBER



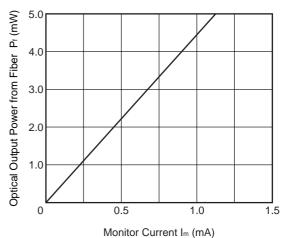
### FORWARD CURRENT vs.



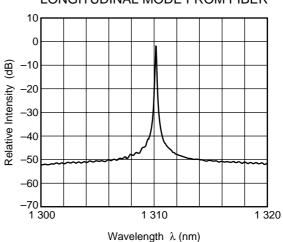
## OPERATING CURRENT AND THRESHOLD CURRENT vs. CASE TEMPERATURE

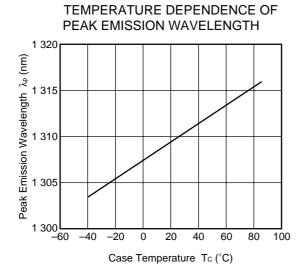


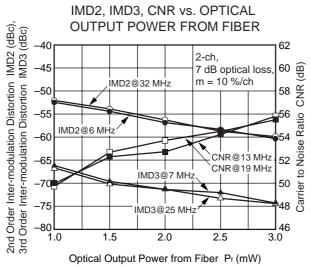
## OPTICAL OUTPUT POWER FROM FIBER vs.MONITOR CURRENT



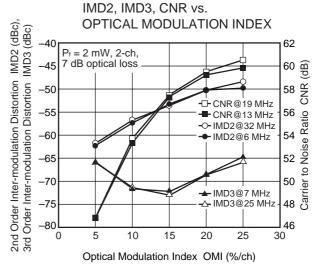
#### LONGITUDINAL MODE FROM FIBER







IMD2, IMD3, CNR vs. CASE TEMPERATURE 2nd Order Inter-modulation Distortion IMD2 (dBc), 3rd Order Inter-modulation Distortion IMD3 (dBc)  $P_f = 2 \text{ mW}, 2\text{-ch},$ 60 මු 7 dB optical loss,  $m = 10^{\circ} \%/ch$ IMD2@6 MHz -50 IMD2@32 MHz -55 -60 CNR@13 MHz -65 IMD3@7 MHz CNR@19 MHz IMD3@25 MHz -70 46 <del>-</del>60 -40 20 40 80 100 Case Temperature Tc (°C)



Remark The graphs indicate nominal characteristics.

#### **★** REFERENCE

Document Name	Document No.		
NEC semiconductor device reliability/quality control system	C11159E		
Quality grades on NEC semiconductor devices	C11531E		
Semiconductor device mounting technology manual	C10535E		
SEMICONDUCTORS SELECTION GUIDE Products & Packages (CD-ROM)	X13769X		

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#### **CAUTION**

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.



SEMICONDUCTOR LASER

**AVOID EXPOSURE-Invisible** Laser Radiation is emitted from this aperture

NEC Corporation NEC Building, 7-1, Shiba 5-chome, Minato-ku, Tokyo 108-01, Japan

Type number: Manufactured: Serial Number:

This product conforms to FDA

regulations as applicable to standards 21 CFR Chapter 1.

Subchapter J.

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